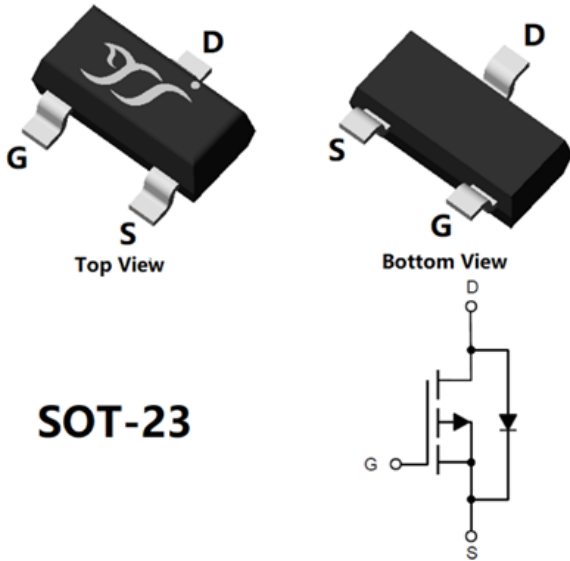


P-Channel Enhancement Mode Field Effect Transistor



SOT-23

Product Summary

- V_{DS} -40V
- I_D -3A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) <80m Ω
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) <110m Ω

General Description

- Trench Power LV MOSFET technology
- High Speed switching
- Halogen Free
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power switching application
- Uninterruptible power supply
- PWM application

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-source Voltage	V_{DS}	-40	V	
Gate-source Voltage	V_{GS}	± 20	V	
Drain Current	I_D	$T_A=25$	-3	A
		$T_A=100$	-1.9	
Pulsed Drain Current ^A	I_{DM}	-20	A	
Total Power Dissipation ^B	P_D	$T_A=25$	1	W
		$T_A=100$	0.4	
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150		

■ Thermal resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^C	$R_{\theta JA}$	100	120	/W

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJL03P04A	F2	03P04.	3000	30000	120000	7 " reel



YJL03P04A

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-40V, V _{GS} =0V, T _J =150	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.5	-2.5	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-3A	-	61	80	mΩ
		V _{GS} =-4.5V, I _D =-2A	-	81	110	
Diode Forward Voltage	V _{SD}	I _S =-3A, V _{GS} =0V	-	-0.85	-1.2	V
Gate resistance	R _G	f=1MHz	-	20	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	-3	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-20V, V _{GS} =0V, f=1MHz	-	400	-	pF
Output Capacitance	C _{oss}		-	50	-	
Reverse Transfer Capacitance	C _{rss}		-	40	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-20V, I _D =-3A	-	8.5	-	nC
Gate-Source Charge	Q _{gs}		-	1	-	
Gate-Drain Charge	Q _{gd}		-	2	-	
Reverse Recovery Charge	Q _{rr}	I _F =-3A, di/dt=100A/us	-	31	-	nC
Reverse Recovery Time	t _{rr}		-	34	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-10V, V _{DD} =-20V, I _D =-3A R _{GEN} =3Ω	-	6	-	ns
Turn-on Rise Time	t _r		-	6	-	
Turn-off Delay Time	t _{D(off)}		-	31	-	
Turn-off fall Time	t _f		-	19	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. P_d is based on max. junction temperature, using junction-case thermal resistance.

C. The value of R_{θJA} is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A=25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

Typical Electrical and Thermal Characteristics Diagrams

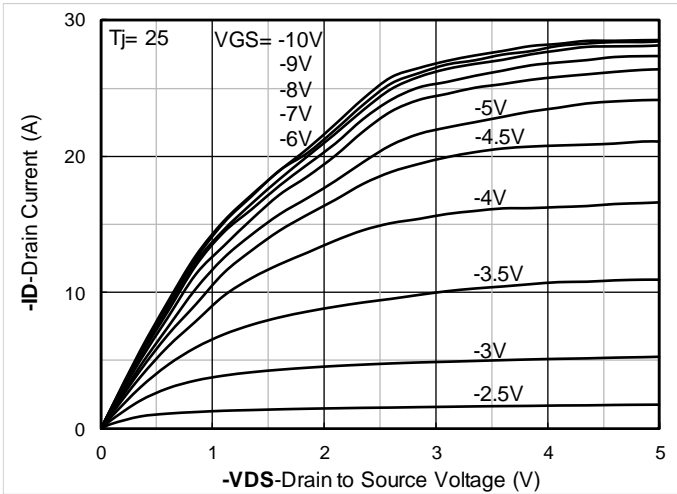


Figure 1. Output Characteristics

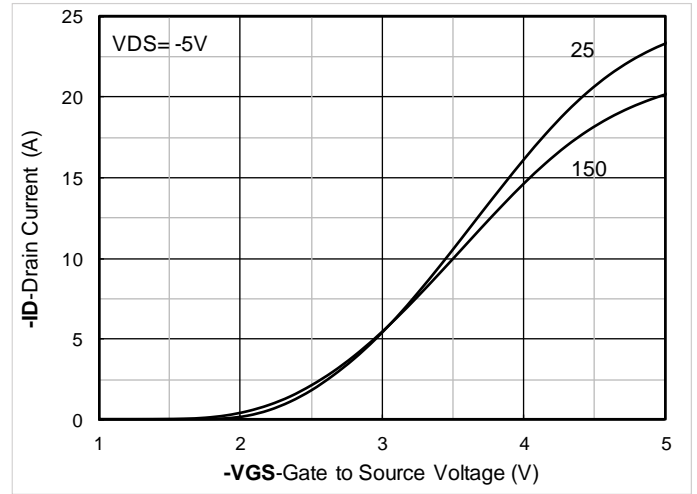


Figure 2. Transfer Characteristics

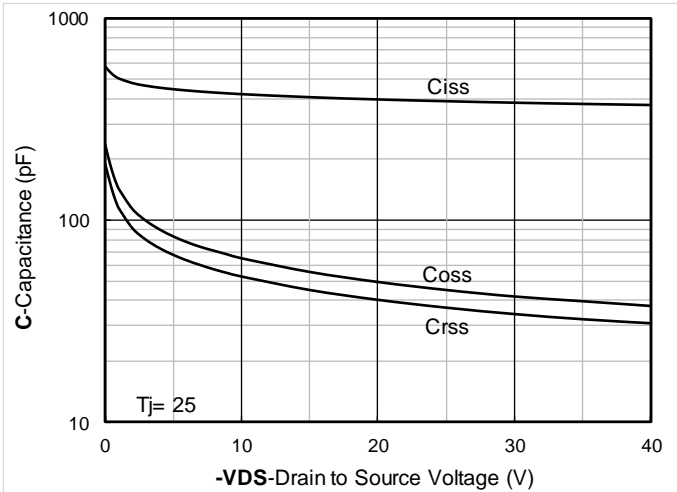


Figure 3. Capacitance Characteristics

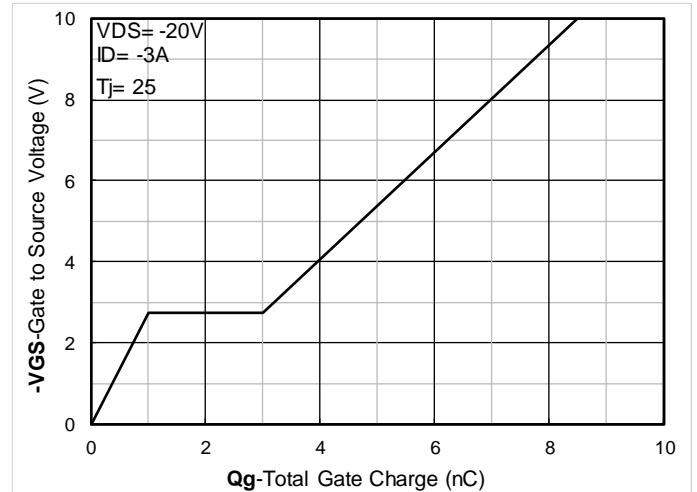


Figure 4. Gate Charge

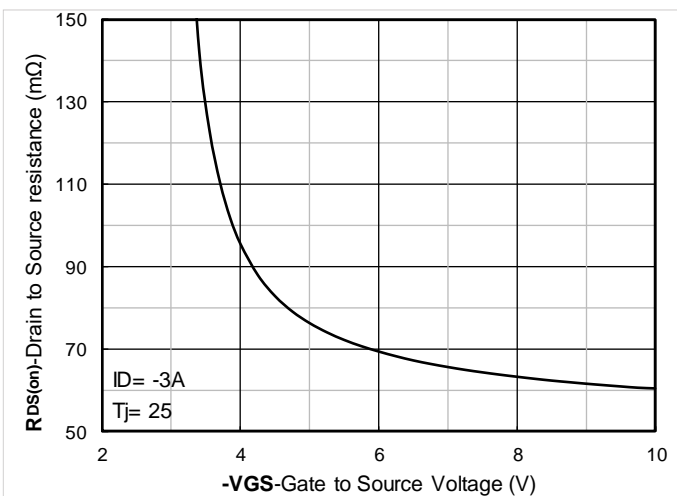


Figure 5. On-Resistance vs Gate to Source Voltage

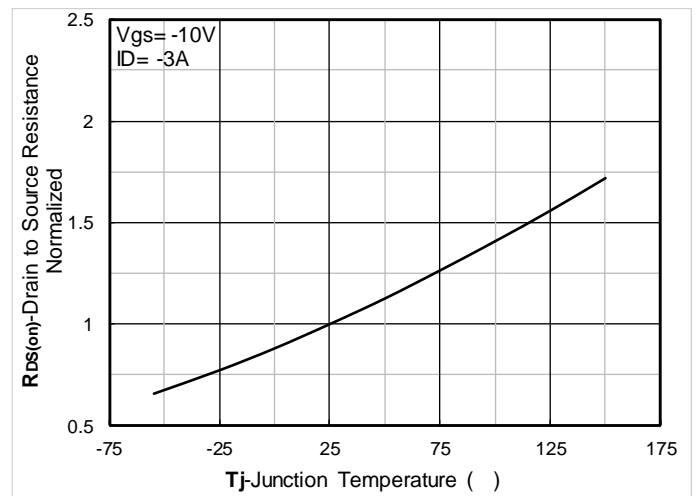


Figure 6. Normalized On-Resistance

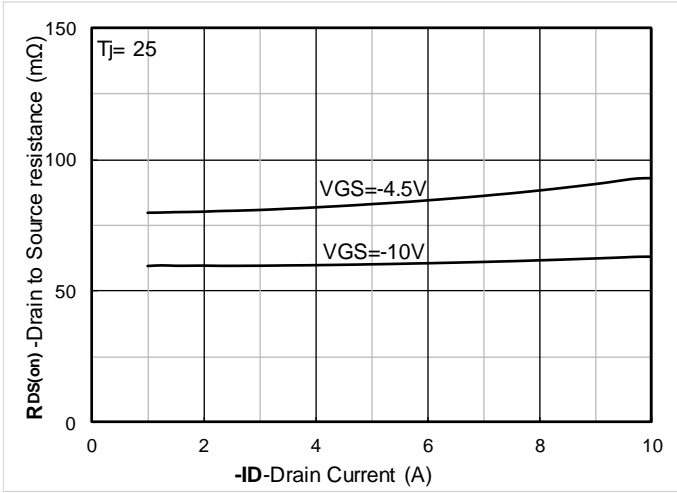


Figure 7. RDS(on) VS Drain Current

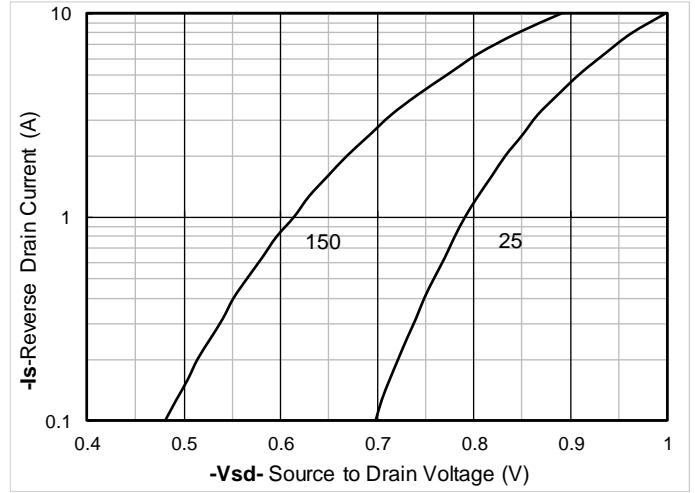


Figure 8. Forward characteristics of reverse diode

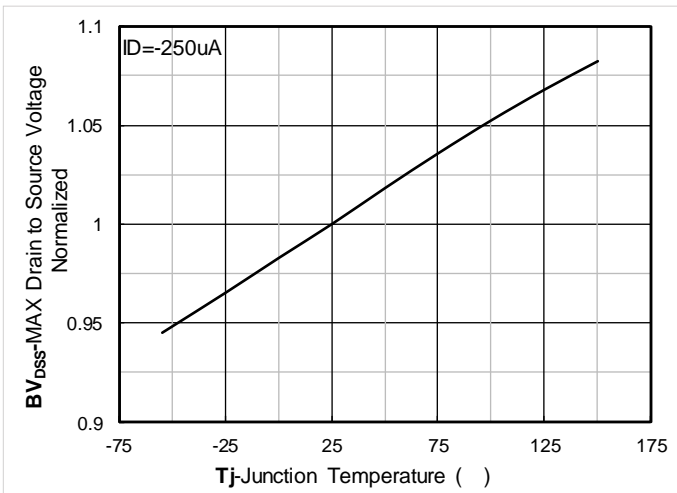


Figure 9. Normalized breakdown voltage

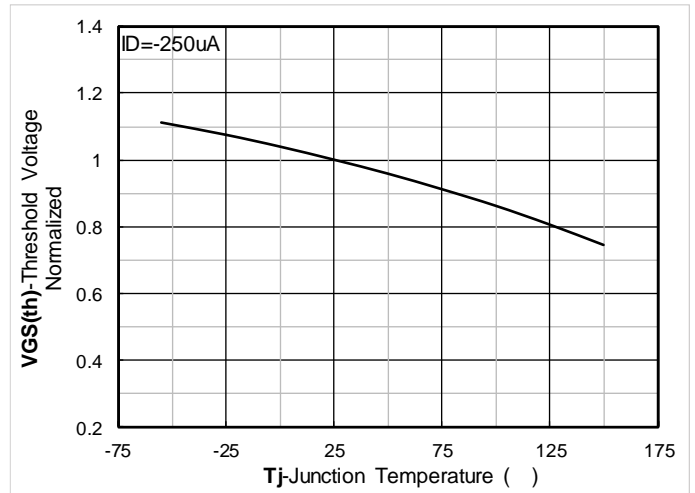


Figure 10. Normalized Threshold voltage

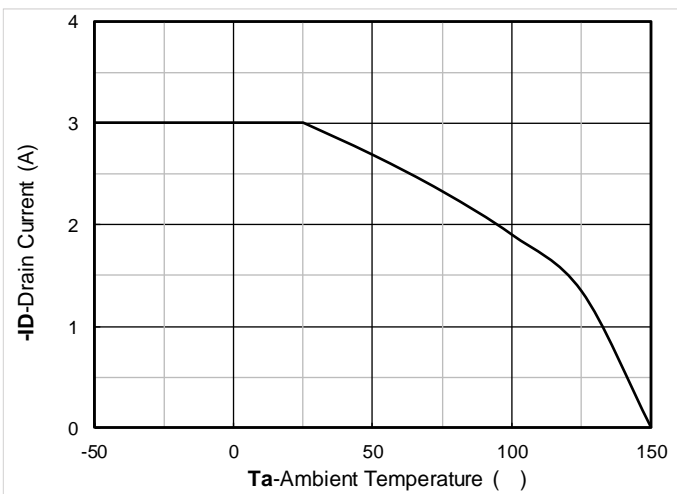


Figure 11. Current dissipation

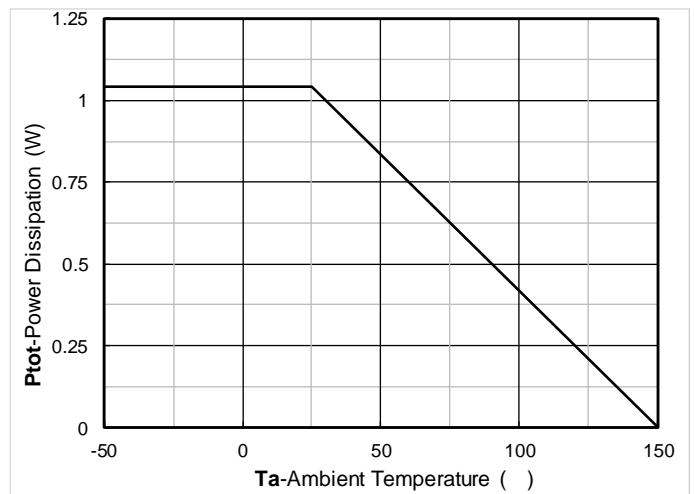


Figure 12. Power dissipation



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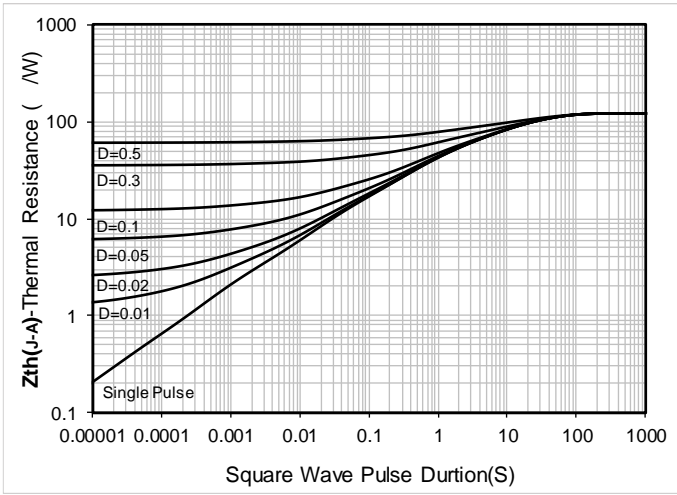


Figure 13. Maximum Transient Thermal Impedance

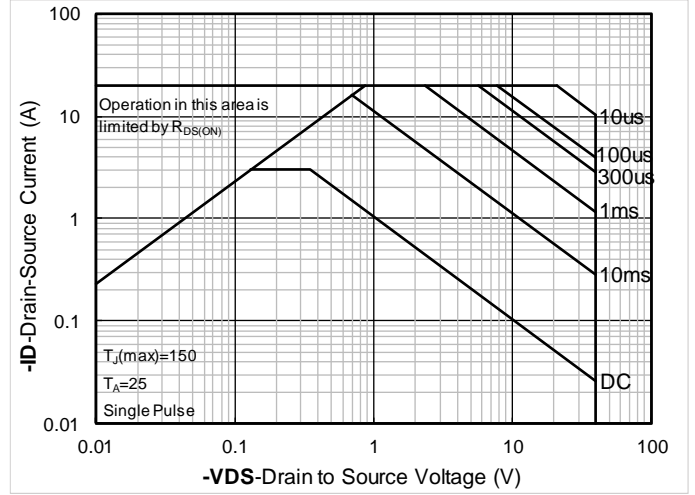
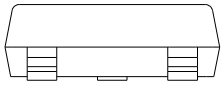
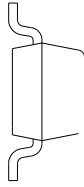


Figure 14. Safe Operation Area



■ SOT-23 Package information



UNIT: mm



YJL03P04A

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